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July 2014

2N4403 / MMBT4403
PNP General-Purpose Amplifier

Description

This device is designed for use as a general-purpose amplifier and switch for collector currents to 500 mA.

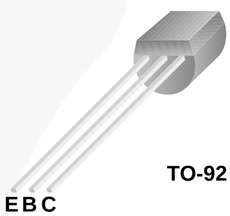

Figure 1. 2N4403 Device Package

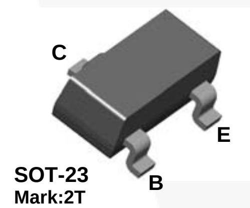

Figure 2. MMBT4403 Device Package

Ordering Information

Part Number	Marking	Package	Packing Method
2N4403BU	2N4403	TO-92 3L	Bulk
2N4403TF	2N4403	TO-92 3L	Tape and Reel
2N4403TFR	2N4403	TO-92 3L	Tape and Reel
2N4403TA	2N4403	TO-92 3L	Ammo
2N4403TAR	2N4403	TO-92 3L	Ammo
MMBT4403	2T	SOT-23 3L	Tape and Reel

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Absolute Maximum Ratings(1),(2)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25°C$ unless otherwise noted.

Symbol	Parameter	Value	Unit
V_{CEO}	Collector-Emitter Voltage	-40	V
V_{CBO}	Collector-Base Voltage	-40	V
V_{EBO}	Emitter-Base Voltage	-5.0	V
I_C	Collector Current - Continuous	-600	mA
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to +150	°C

Notes:
1. These ratings are based on a maximum junction temperature of 150°C.
2. These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed or low-duty cycle operations.

Thermal Characteristics

Values are at $T_A = 25°C$ unless otherwise noted.

Symbol	Parameter	Max.		Unit
		2N4403(3)	**MMBT4403(4)**	
P_D	Total Device Dissipation	625	350	mW
	Derate Above 25°C	5.0	2.8	mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	83.3		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	357	°C/W

Notes:
3. PCB size: FR-4, 76 mm x 114 mm x 1.57 mm (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.
4. Device mounted on FR-4 PCB 1.6 inch x 1.6 inch x 0.06 inch.

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Electrical Characteristics

Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Max.	Unit
Off Characteristics					
$V_{(BR)CEO}$	Collector-Emitter Breakdown Voltage(5)	I_C = -1.0 mA, I_B = 0	-40		V
$V_{(BR)CBO}$	Collector-Base Breakdown Voltage	I_C = -0.1 mA, I_E = 0	-40		V
$V_{(BR)EBO}$	Emitter-Base Breakdown Voltage	I_E = -0.1 mA, I_C = 0	-5.0		V
I_{BL}	Base Cut-Off Current	V_{CE} = -35 V, V_{EB} = -0.4 V		-0.1	µA
I_{CEX}	Collector Cut-Off Current	V_{CE} = -35 V, V_{EB} = -0.4 V		-0.1	µA
On Characteristics					
h_{FE}	DC Current Gain	I_C = -0.1 mA, V_{CE} = -1.0 V	30		
		I_C = -1.0 mA, V_{CE} = -1.0 V	60		
		I_C = -10 mA, V_{CE} = -1.0 V	100		
		I_C = -150 mA, V_{CE} = -2.0 V(5)	100	300	
		I_C = -500 mA, V_{CE} = -2.0 V(5)	20		
V_{CE}(sat)	Collector-Emitter Saturation Voltage(5)	I_C = -150 mA, I_B = -15 mA		-0.40	V
		I_C = -500 mA, I_B = -50 mA		-0.75	
V_{BE}(sat)	Base-Emitter Saturation Voltage	I_C = -150 mA, I_B = -15 mA(5)	-0.75	-0.95	V
		I_C = -500 mA, I_B = -50 mA		-1.30	
Small Signal Characteristics					
f_T	Current Gain - Bandwidth Product	I_C = -20 mA, V_{CE} = -10 V, f = 100 MHz	200		MHz
C_{cb}	Collector-Base Capacitance	V_{CB} = -10 V, I_E = 0, f = 140 kHz		8.5	pF
C_{eb}	Emitter-Base Capacitance	V_{BE} = -0.5 V, I_C = 0, f = 140 kHz		30	pF
h_{ie}	Input Impedance	I_C = -1.0 mA, V_{CE} = -10 V, f = 1.0 kHz	1.5	15.0	kΩ
h_{re}	Voltage Feedback Ratio	I_C = -1.0 mA, V_{CE} = -10 V, f = 1.0 kHz	0.1	8.0	$x10^{-4}$
h_{fe}	Small-Signal Current Gain	I_C = -1.0 mA, V_{CE} = -10 V, f = 1.0 kHz	60	500	
h_{oe}	Output Admittance	I_C = -1.0 mA, V_{CE} = -10 V, f = 1.0 kHz	1	100	µmhos
Switching Characteristics					
t_d	Delay Time	V_{CC} = -30 V, I_C = -150 mA, I_{B1} = -15 mA		15	ns
t_r	Rise Time			20	ns
t_s	Storage Time	V_{CC} = -30 V, I_C = -150 mA, I_{B1} = I_{B2} = -15 mA		225	ns
t_f	Fall Time			30	ns

Note:

5. Pulse test: pulse width ≤ 300 µs, duty cycle ≤ 2.0%.

Typical Performance Characteristics

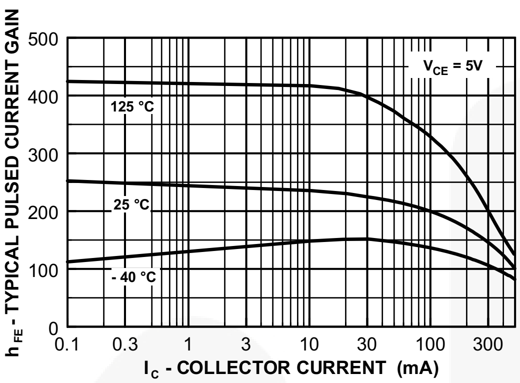

Figure 3. Typical Pulsed Current Gain vs. Collector Current

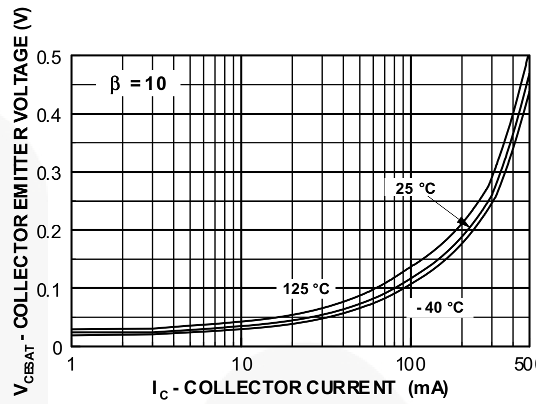

Figure 4. Collector-Emitter Saturation Voltage vs. Collector Current

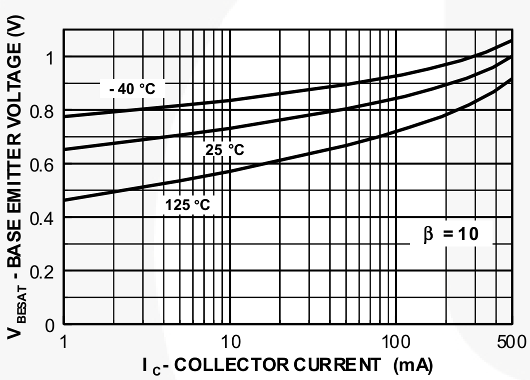

Figure 5. Base-Emitter Saturation Voltage vs. Collector Current

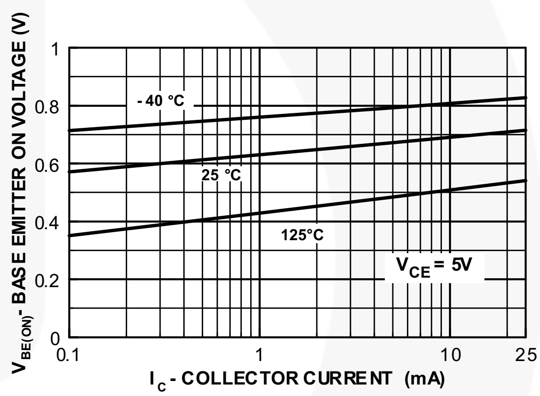

Figure 6. Base-Emitter On Voltage vs. Collector Current

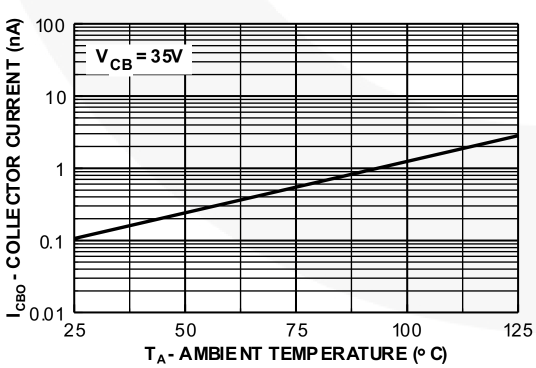

Figure 7. Collector Cut-Off Current vs. Ambient Temperature

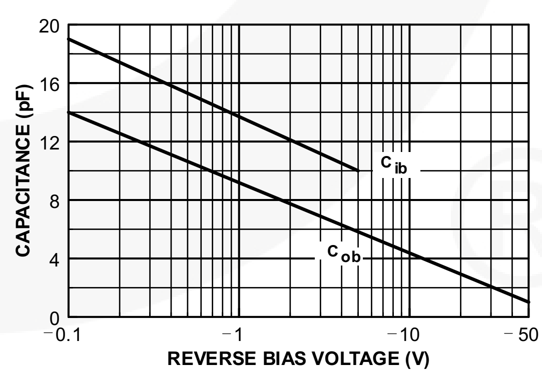

Figure 8. Input and Output Capacitance vs. Reverse Bias Voltage

Typical Performance Characteristics (Continued)

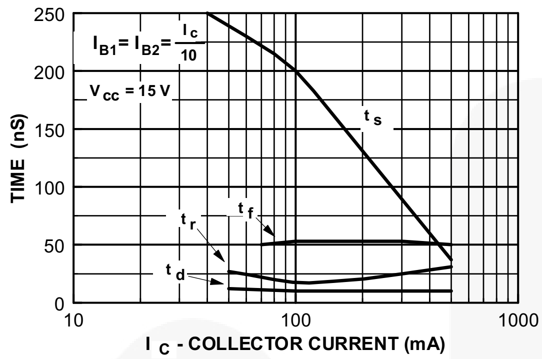

Figure 9. Switching Times vs. Collector Current

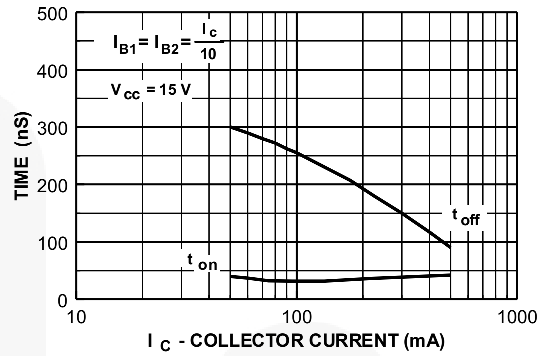

Figure 10. Turn-On and Turn-Off Times vs. Collector Current

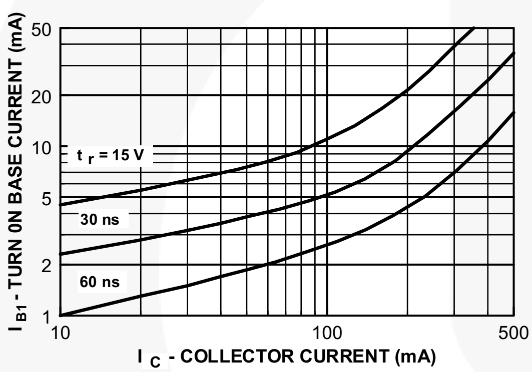

Figure 11. Rise Time vs. Collector and Turn-On Base Currents

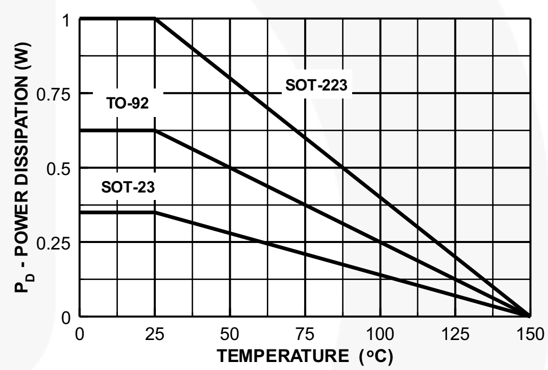

Figure 12. Power Dissipation vs. Ambient Temperature

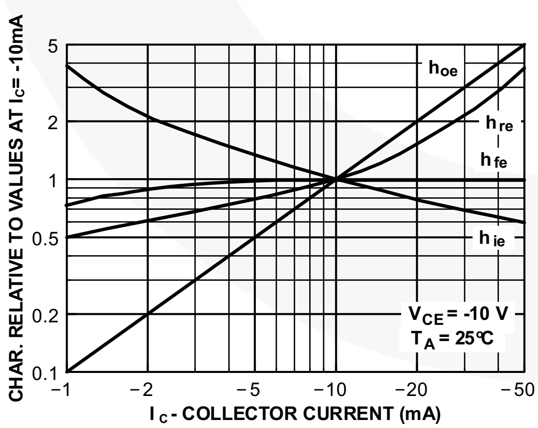

Figure 13. Common Emitter Characteristics

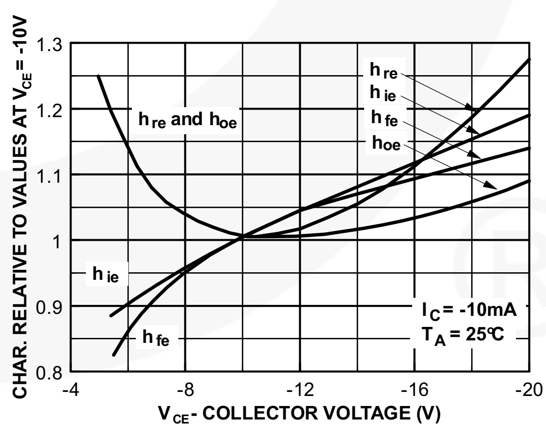

Figure 14. Common Emitter Characteristics

Typical Performance Characteristics (Continued)

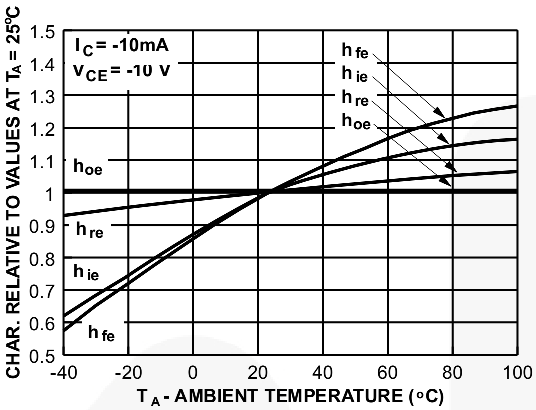

Figure 15. Common Emitter Characteristics

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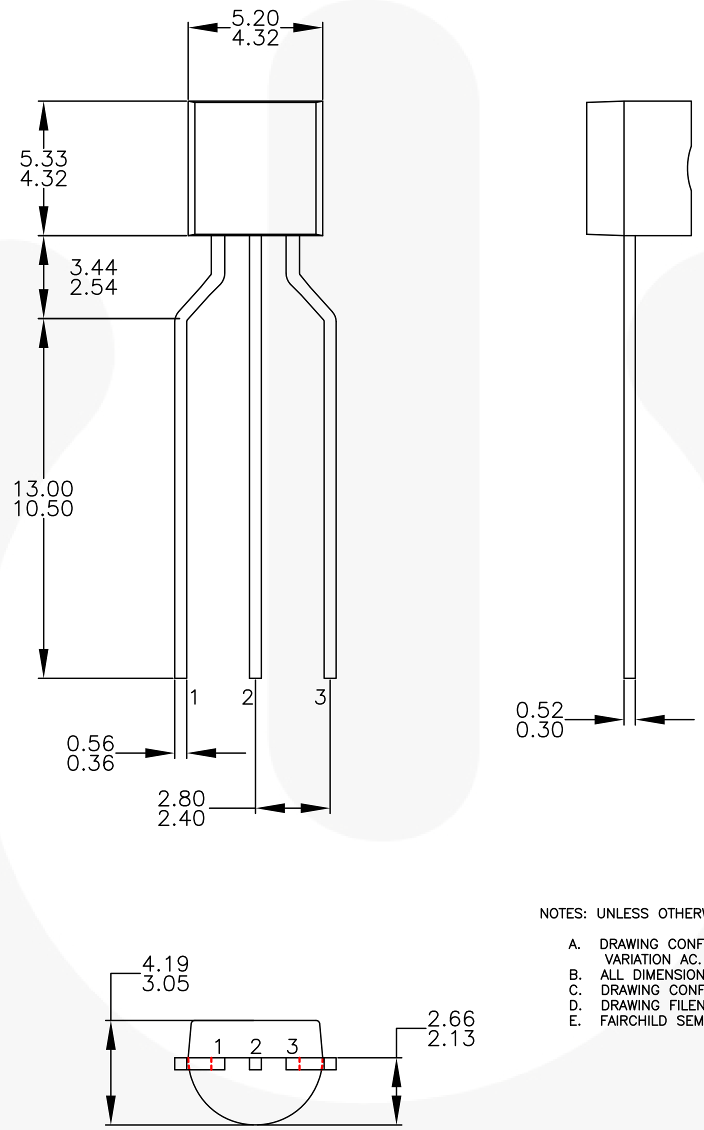
Physical Dimensions

TO-92 3L (Tape and Reel, Ammo)



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B. ALL DIMENSIONS ARE IN MILLIMETERS.
C. DRAWING CONFORMS TO ASME Y14.5M–2009.
D. DRAWING FILENAME: MKT–ZA03FREV3.
E. FAIRCHILD SEMICONDUCTOR.

Figure 16. 3-LEAD, TO-92, MOLDED 0.200 IN LINE SPACING LD FORM (J61Z OPTION) (ACTIVE)

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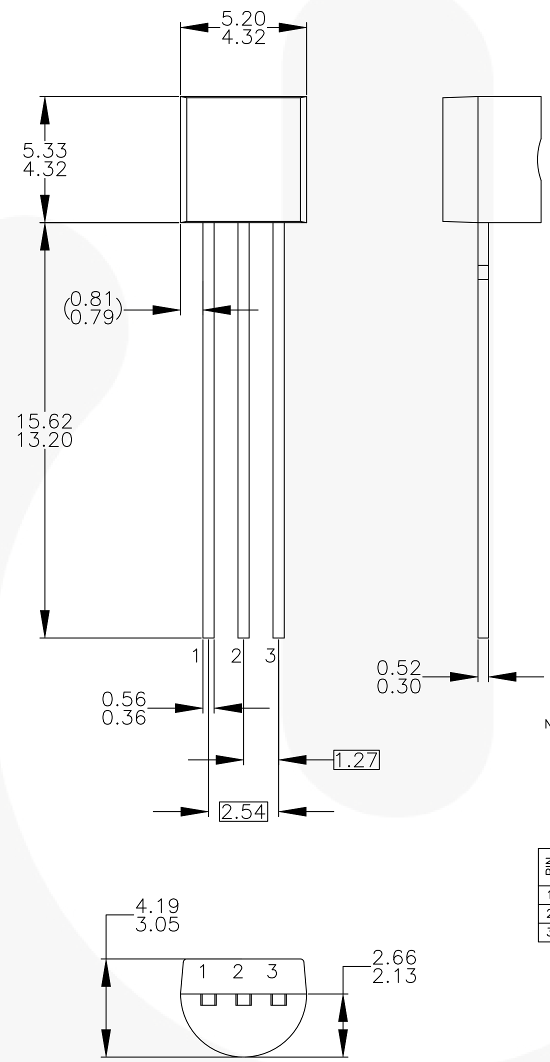
Physical Dimensions (Continued)

TO-92 3L (Bulk)



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A) DRAWING WITH REFERENCE TO JEDEC TO−92 RECOMMENDATIONS.
B) ALL DIMENSIONS ARE IN MILLIMETERS.
C) DRAWING CONFORMS TO ASME Y14.5M−1994.
D) TO−92 (92,94,96,97,98) PIN CONFIGURATION:

PIN	92			94			96			97			98		
	P	F	M	P	F	M	B	F	M	P	F	M	P	F	M
1	E	S	S	E	S	S	B	D	G	C	G	D	C	G	D
2	B	D	G	C	G	D	E	S	S	B	D	G	E	S	S
3	C	G	D	B	D	G	C	G	D	E	S	S	B	D	G

LEGEND:
P − BIPOLAR   E − EMITTER   D − DRAIN
F − JFET   B − BASE   S − SOURCE
M − DMOS   C − COLLECTOR   G − GATE

E) FOR PACKAGE 92, 94, 96, 97 AND 98: PIN CONFIGURATION DRAIN "D" AND SOURCE "S" ARE INTERCHANGEAGLE AT JFET "F" OPTION.
F) DRAWING FILENAME: MKT−ZA03DREV3.

Figure 17. 3-LEAD, JEDEC TO-92 COMPLIANT STRAGHIT LEAD CONFIGURATION (OLD TO92AM3)

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Physical Dimensions (Continued)

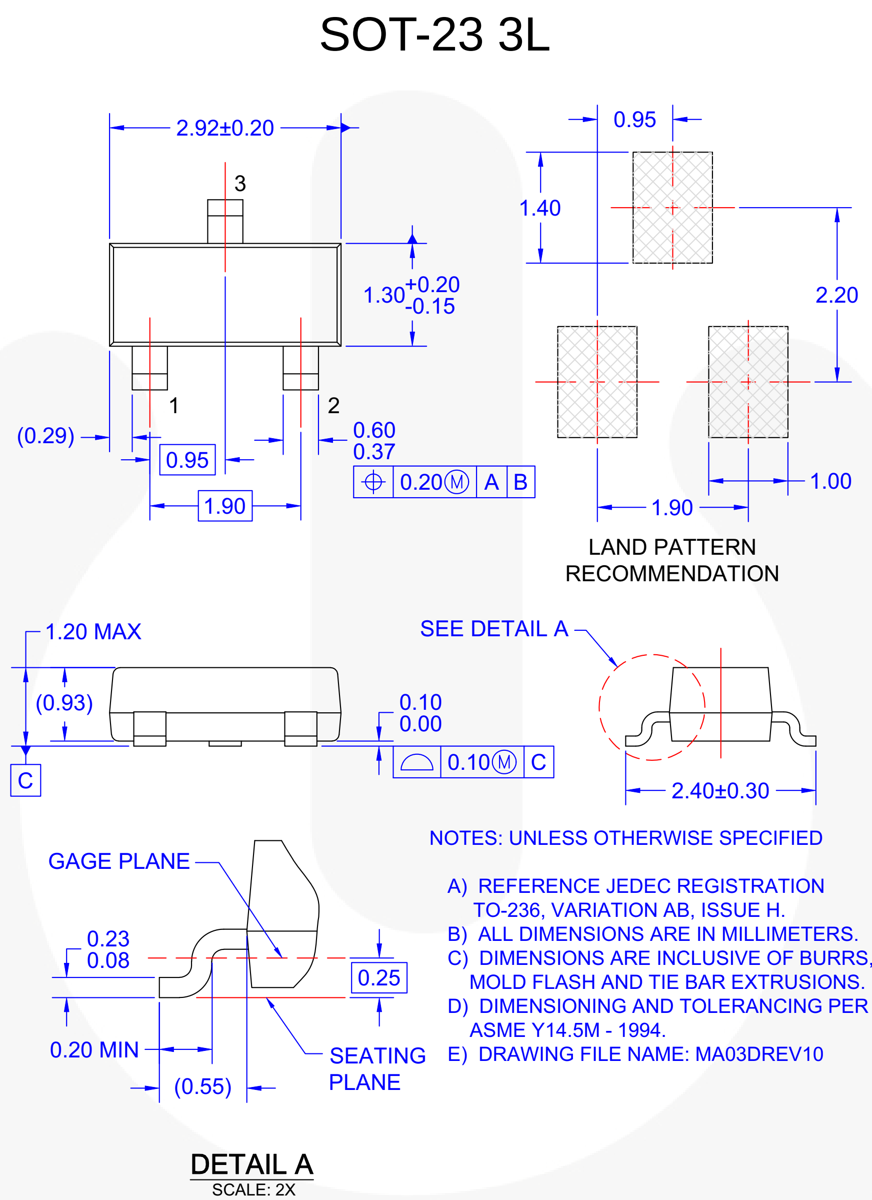

Figure 18. 3-LEAD, SOT23, JEDEC TO-236, LOW PROFILE (ACTIVE)

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Живое партнерство

ООО "ЛайфЭлектроникс" "LifeElectronics" LLC

ИНН 7805602321 КПП 780501001 Р/С 40702810122510004610 ФАКБ "АБСОЛЮТ БАНК" (ЗАО) в г.Санкт-Петербурге К/С 30101810900000000703 БИК 044030703

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- *Конкурентоспособные цены и скидки постоянным клиентам.*
- *Специальные условия для постоянных клиентов.*
- *Подбор аналогов.*
- *Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.*

- *Приемлемые сроки поставки, возможна ускоренная поставка.*
- *Доставку товара в любую точку России и стран СНГ.*
- *Комплексную поставку.*
- *Работу по проектам и поставку образцов.*
- *Формирование склада под заказчика.*

- *Сертификаты соответствия на поставляемую продукцию (по желанию клиента).*
- *Тестирование поставляемой продукции.*
- *Поставку компонентов, требующих военную и космическую приемку.*
- *Входной контроль качества.*
- *Наличие сертификата ISO.*

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- *Регистрацию проекта у производителя компонентов.*
- *Техническую поддержку проекта.*
- *Защиту от снятия компонента с производства.*
- *Оценку стоимости проекта по компонентам.*
- *Изготовление тестовой платы монтаж и пусконаладочные работы.*

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